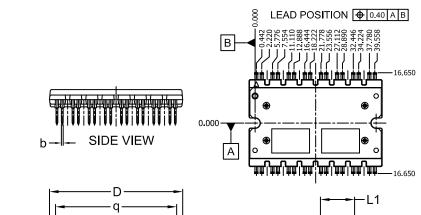


APM32 AUTOMOTIVE MODULE

CASE MODHL ISSUE B

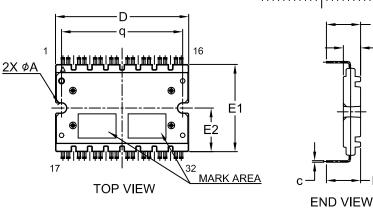
DATE 05 APR 2022

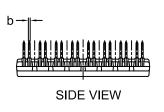


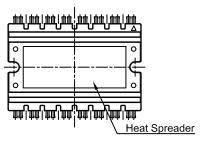
NOTES:

- DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

	MILLIMETERS		
DIM	MIN.	NOM	MAX.
A2	5.60	5.70	5.80
р	0.50	0.60	0.70
С	0.45	0.50	0.60
D	43.80	44.00	44.20
E1	28.60	28.80	29.00
E2	14.25	14.40	14.55
L1	11.00	11.30	11.60
q	39.85	40.00	40.15
ØΑ	3.20	3.30	3.40







A2

BOTTOM VIEW

GENERIC MARKING DIAGRAM*

XXXX = Specific Device Code

ZZZ = Lot ID

AT = Assembly & Test Location

Y = Year W = Work Week NNN = Serial Number *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	APM32 AUTOMOTIVE MOI	DULE	PAGE 1 OF 1

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